

# NCE N-Channel Enhancement Mode Power MOSFET

## Description

The NCE8290AC uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

### **General Features**

- V<sub>DS</sub> =82V,I<sub>D</sub> =90A
  R<sub>DS(ON)</sub> < 12 mΩ @ V<sub>GS</sub>=10V (Typ:9mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Special designed for convertors and power controls
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

## Application

- Power switching application
- Hard switched and High frequency circuits
- Uninterruptible power supply

#### 100% UIS TESTED!

#### 100% ΔVds TESTED!

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE8290AC	NCE8290AC	TO-220-3L	-	-	-

#### Absolute Maximum Ratings (T<sub>A</sub>=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	82	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	90	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	63.6	A
Pulsed Drain Current	I <sub>DM</sub>	320	A
Maximum Power Dissipation	PD	130	W
Derating factor		0.87	<b>W</b> /°C
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	380	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 175	°C



TO-220-3L top view

(2) D



#### **Thermal Characteristic**

Thermal Resistance.Ju	unction-to-Case <sup>(Note 2)</sup>	$R_{ extsf{ heta}JC}$	1.15	°C/W
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## Electrical Characteristics (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	82	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =82V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =10V, I <sub>D</sub> =20A	-	9	12	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	-	30	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C <sub>lss</sub>		-	4414	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz	-	219	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0WHZ	-	188	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	19	-	nS
Turn-on Rise Time	tr	$V_{DD}$ =40V,RL=15 $\Omega$	-	12	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G$ =2.5 $\Omega$ , $V_{GS}$ =10V	-	40	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	15	-	nS
Total Gate Charge	Qg	)/ _40)/1 _204	-	81.5	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =40V,I <sub>D</sub> =20A,	-	26.9	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	23.7	-	nC
Drain-Source Diode Characteristics			•			•
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	90	А
Reverse Recovery Time	t <sub>rr</sub>	Tj=25℃,I <sub>F</sub> =20A	-	36	-	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs <sup>(Note3)</sup>	-	54	-	nC

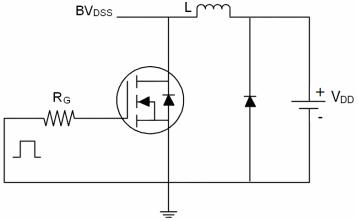
### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ C, V_{DD}$ =40V, V\_G=10V, L=0.5mH, Rg=25 $\Omega$

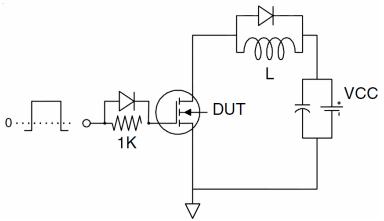


# **Test Circuit**

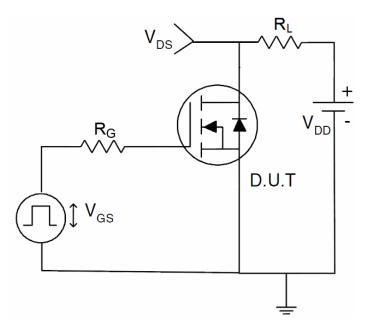
1) E<sub>AS</sub> Test Circuits



## 2) Gate Charge Test Circuit

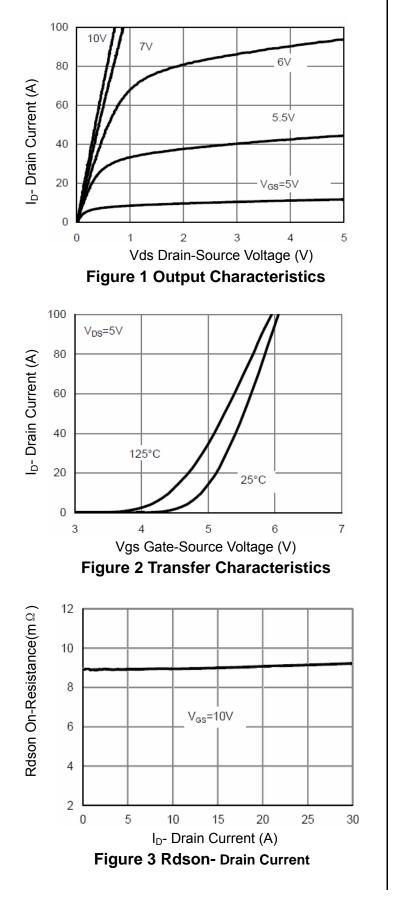


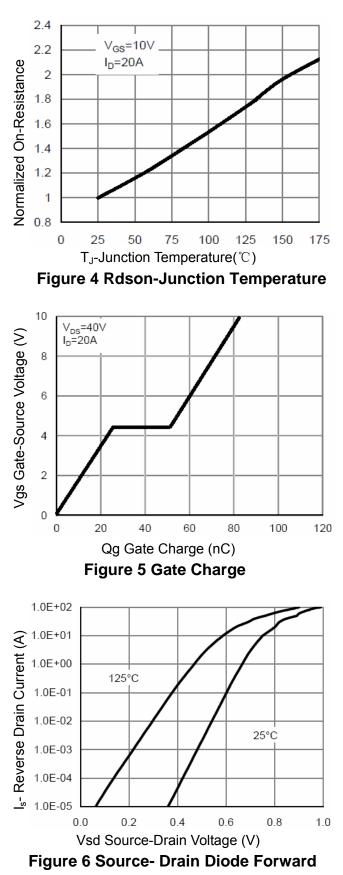
## 3) Switch Time Test Circuit





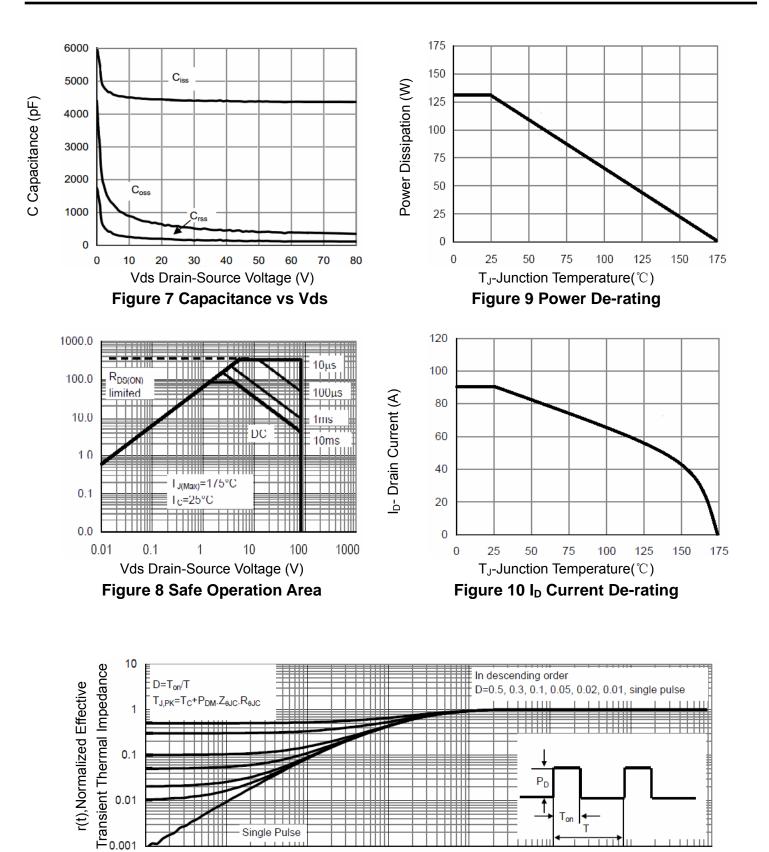
## **Typical Electrical and Thermal Characteristics (Curves**







#### http://www.ncepower.com



0.01

0.1

1

0.001

0.000001

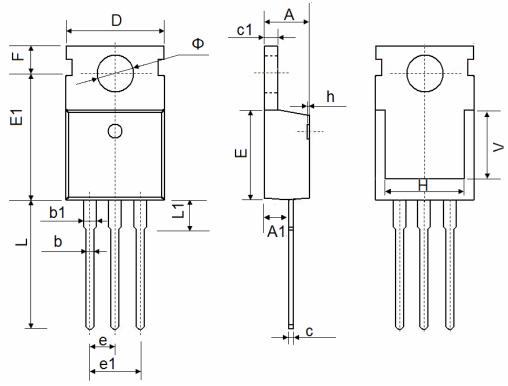
0.00001

0.0001

10



# TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.54	0 TYP. 0.1		0 TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	7.500 REF.		REF.	
Φ	3.400	3.800	0.134	0.150	



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